

#1 Coating Technology in The World Molecule Gradient Layer (MGL)[™] Technology

Heat resistant masking tape based polyimide with strong adhesive force

Feature

Heat resistant tape baced Polyimide for solder-process

Have excellent performance to not only metal but also various resin.

Stable adhesion even at high temperature

We do not use 13 substances specified by VOC such as formaldehyde, acetaldehyde, toluene, etc. as constituent materials, as determined by guidelines for indoor air pollution

(Ministry of Health, Labor and Welfare).

Application

Fixation for electronics-parts or semiconductor chip parts

Fixation of parts

Fixation with water-proof

Structure



Polyethyleneterephtalate with release-treatment on surface Special structure acrylic adhesive layer Polyimide film as base

Properties

general properties

item	Thickness base layer	Thickness adhesive layer	Adhesive force SUS(25°C	Adhesive force SUS(200°C
	(μm)	(mm)	(N/inch)	(MPa)
179	12.5	12.5	3	5
≫Measure		Adhesive force	JIS Z0237	

Adhesive force

PET#25 backing, peeling speed 300mm/min, 180° angle.

Precautions on use

All technical data are prepared based on the tests and measured values carried out in the laboratory of KGK Chemical Corp. as the standard.

However, product characteristics may vary greatly depending on environment and adherend. Therefore, regarding these characteristic data, it is a reference value, not a guaranteed value. Before using it please make sure that this product is suitable for the intended use and environment.

Caution on storage

Please be sure to put it in a box and keep it.

Please choose a cold and dark place not to be exposed to direct sunlight for the storage location.

In particular, please do not expose to high temperature and high humidity

(temperature 30 °C or more and humidity 50% or more forbidden). 940 Minaminagai Tokorozawa-City saitama-Pref The warranty period of the tape is unopened and it is six months after shipment. 359-0011 Japan

KGK Chemical Corp.